

Special Issue

Novel Magnetic Materials and Magnetism in Spintronics

Message from the Guest Editor

As the field of spintronics undergoes swift advancements, an increasing array of sophisticated magnetic materials is being unveiled, showcasing parallel growth in magnetism. This Special Issue within *Inventions*, published by MDPI, spotlights key topics such as the synthesis methodologies for magnetic materials, especially nanoscale materials, advancements in 2D magnetic materials and 2D spintronic devices, techniques for measuring and characterizing magnetic materials, applications of magnetic materials, innovations in spintronic devices, and the exploration of magnetism associated with novel magnetic materials and spintronic devices.

Guest Editor

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